

SMD Power Inductor

TMPF0621HC-Series(D)-D

1. Features

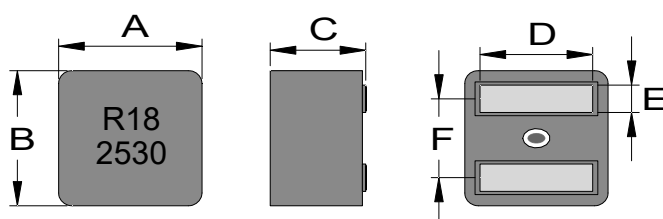
1. Low loss realized with low DCR.
2. High performance realized by metal dust core.
3. Ultra low buzz noise, due to composite construction.
4. 100% Lead(Pb)-Free & Halogen-Free and RoHS compliant.
5. Operating temperature: -40~+125℃(Including self - temperature rise)



2. Applications

Commercial applications

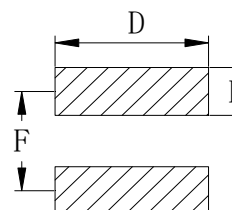
3. Dimensions



A	B	C	D	E	F
6.8±0.2	6.6±0.2	1.9±0.2	5.1±0.3	1.25±0.15	4.1±0.25

Unit:mm

Recommend PC Board Pattern



D	E	F
5.5	1.5	4.1

Note: 1.PCB layout is referred to standard IPC-7351B
 2. The above PCB layout reference only.
 3. Recommend solder paste thickness at 0.15mm and above.

4. Part Numbering

TMPF	0621	HC	-	R18	MD	-	D
A	B	C		D	E		F

A: Series

B: Dimension

C: Type

D: Inductance

E: Inductance Tolerance

F: Code

BxC

Material.

R18=0.18uH

M=±20%, D=Coating

Marking: Black.R18 and 2530 (25 YY, 30 WW, follow production date).

5. Specification

Part Number	Inductance (uH) $\pm 20\%$ @ 0 A DC	I rms (A)		I sat (A)		DCR (mΩ)	
		Typ	Max	Typ	Max	Typ	Max
TMPF0621HC-R18MD-D	0.18	34.0	32.0	40.0	36.0	1.3	1.6
TMPF0621HC-R20MD-D	0.20	32.0	30.0	37.0	33.0	1.5	1.8
TMPF0621HC-R22MD-D	0.22	30.0	28.0	35.0	31.0	1.7	2.1
TMPF0621HC-R33MD-D	0.33	28.0	25.0	30.0	27.0	2.0	2.5
TMPF0621HC-R36MD-D	0.36	25.0	23.0	28.0	26.0	2.5	3.0
TMPF0621HC-R47MD-D	0.47	22.0	20.0	26.0	24.0	3.4	4.1
TMPF0621HC-R56MD-D	0.56	20.0	18.0	20.0	18.0	3.7	4.4
TMPF0621HC-R68MD-D	0.68	19.0	17.0	17.0	15.0	4.0	4.8
TMPF0621HC-R82MD-D	0.82	17.0	15.0	15.0	13.0	4.8	5.8
TMPF0621HC-1R0MD-D	1.00	15.0	13.0	14.0	12.0	5.8	7.0
TMPF0621HC-1R2MD-D	1.20	14.0	12.0	13.0	11.0	7.0	8.4
TMPF0621HC-1R5MD-D	1.50	13.0	11.5	12.5	10.5	7.9	9.5
TMPF0621HC-1R8MD-D	1.80	12.5	11.0	11.0	10.0	9.0	10.8
TMPF0621HC-2R2MD-D	2.20	11.5	10.5	10.0	9.0	12.5	14.4
TMPF0621HC-3R3MD-D	3.30	9.5	8.5	8.5	7.5	16.5	19.8
TMPF0621HC-4R7MD-D	4.70	8.0	7.0	7.5	6.5	23.5	28.2
TMPF0621HC-5R6MD-D	5.60	7.2	6.5	6.5	5.7	27.5	33.0
TMPF0621HC-6R2MD-D	6.20	6.7	6.2	5.8	5.3	32.0	38.4
TMPF0621HC-6R8MD-D	6.80	6.5	5.8	5.3	4.7	38.0	45.6

Note:

1. Test frequency : L_s : 100KHz /1.0V.
2. All test data referenced to 25℃ ambient.
3. Testing Instrument(or equ) : Agilent 4284A,E4991A,4339B,KEYSIGHT E4980A/AL,chroma3302,3250,16502.
4. Heat Rated Current (I rms) will cause the coil temperature rise approximately ΔT of 40℃
5. Saturation Current (Isat) will cause L0 to drop approximately 30%.
6. The part temperature (ambient + temp rise) should not exceed 125℃ under worst case operating conditions.Circuit design,component,PCB trace size and thickness,airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.
7. I rms Testing : Temperature rise is highly dependent on many factors including pcb land pattern, trace size, and proximity to other components.
Therefore temperature rise should be verified in application conditions.
8. Rated DC current: The lower value of I rms and Isat.

6. Typical Performance Curves

